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Details

Product StatusObsoleteCore Processor8051Core Size8-BitSpeed12MHzConnectivitySPI, UART/USARTPeripheralsPOR, WDTNumber of I/O32Program Memory Size12KB (12K × 8)Program Memory TypeFLASHEEPROM Size-RAM Size256 × 8Voltage - Supply (Vcc/Vdd)2.7V ~ 6VData Converters-Oscillator TypeInternalOperating Temperature-40°C ~ 85°C (TA)Mounting TypeThrough HolePackage / Case40-PDIPPurchase URLhttps://www.e-xfl.com/product-detail/microchip-technology/at89ls53-12pi		
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EEPROM Size-RAM Size256 x 8Voltage - Supply (Vcc/Vdd)2.7V ~ 6VData Converters-Oscillator TypeInternalOperating Temperature-40°C ~ 85°C (TA)Mounting TypeThrough HolePackage / Case40-DIP (0.600", 15.24mm)Supplier Device Package40-PDIP	Program Memory Size	12KB (12K x 8)
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Voltage - Supply (Vcc/Vdd)2.7V ~ 6VData Converters-Oscillator TypeInternalOperating Temperature-40°C ~ 85°C (TA)Mounting TypeThrough HolePackage / Case40-DIP (0.600", 15.24mm)Supplier Device Package40-PDIP	EEPROM Size	-
Data Converters-Oscillator TypeInternalOperating Temperature-40°C ~ 85°C (TA)Mounting TypeThrough HolePackage / Case40-DIP (0.600", 15.24mm)Supplier Device Package40-PDIP	RAM Size	256 x 8
Oscillator TypeInternalOperating Temperature-40°C ~ 85°C (TA)Mounting TypeThrough HolePackage / Case40-DIP (0.600", 15.24mm)Supplier Device Package40-PDIP	Voltage - Supply (Vcc/Vdd)	2.7V ~ 6V
Operating Temperature-40°C ~ 85°C (TA)Mounting TypeThrough HolePackage / Case40-DIP (0.600", 15.24mm)Supplier Device Package40-PDIP	Data Converters	-
Mounting Type Through Hole Package / Case 40-DIP (0.600", 15.24mm) Supplier Device Package 40-PDIP	Oscillator Type	Internal
Package / Case 40-DIP (0.600", 15.24mm) Supplier Device Package 40-PDIP	Operating Temperature	-40°C ~ 85°C (TA)
Supplier Device Package 40-PDIP	Mounting Type	Through Hole
	Package / Case	40-DIP (0.600", 15.24mm)
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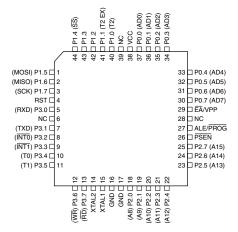


Pin Configurations

			1
(T2) P1.0 🗆	1	40	⊐ vcc
(T2 EX) P1.1 🗆	2	39	D P0.0 (AD0)
P1.2	3	38	DP0.1 (AD1)
P1.3 🗆	4	37	DP0.2 (AD2)
(SS) P1.4 🗆	5	36	DP0.3 (AD3)
(MOSI) P1.5 🗆	6	35	DP0.4 (AD4)
(MISO) P1.6 🗆	7	34	DP0.5 (AD5)
(SCK) P1.7 🗆	8	33	DP0.6 (AD6)
RST 🗆	9	32	DP0.7 (AD7)
(RXD) P3.0 🗆	10	31	EA/VPP
(TXD) P3.1 🗆	11	30	ALE/PROG
(INT0) P3.2 🗆	12	29	D PSEN
(INT1) P3.3 🗆	13	28	🗆 P2.7 (A15)
(T0) P3.4 🗆	14	27	🗆 P2.6 (A14)
(T1) P3.5 🗆	15	26	🗆 P2.5 (A13)
(WR) P3.6 🗆	16	25	🗆 P2.4 (A12)
(RD) P3.7 🗆	17	24	🗆 P2.3 (A11)
XTAL2 🗆	18	23	🗆 P2.2 (A10)
XTAL1 🗆	19	22	🗆 P2.1 (A9)
GND 🗆	20	21	🗆 P2.0 (A8)
			l

PDIP





Pin Description

V_{CC}

Supply voltage.

GND

Ground.

Port 0

2

Port 0 is an 8-bit open drain bidirectional I/O port. As an output port, each pin can sink eight TTL inputs. When 1s are written to port 0 pins, the pins can be used as high-impedance inputs.

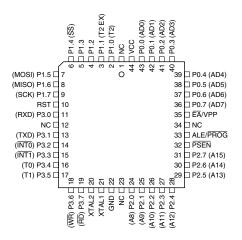
Port 0 can also be configured to be the multiplexed loworder address/data bus during accesses to external program and data memory. In this mode, P0 has internal pullups. Port 0 also receives the code bytes during Flash programming and outputs the code bytes during program verification. External pullups are required during program verification.

Port 1

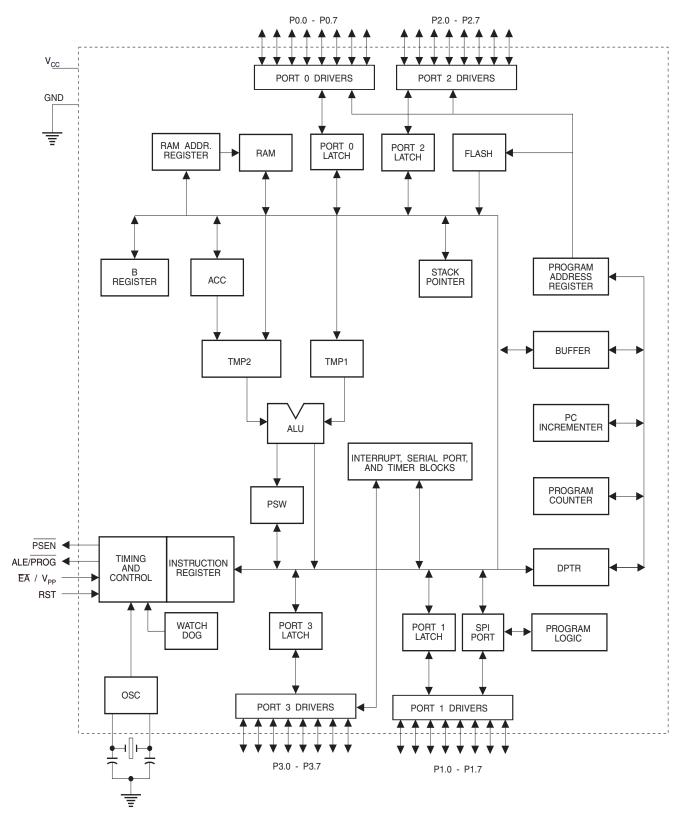
Port 1 is an 8-bit bidirectional I/O port with internal pullups. The Port 1 output buffers can sink/source four TTL inputs. When 1s are written to Port 1 pins, they are pulled high by the internal pullups and can be used as inputs. As inputs, Port 1 pins that are externally being pulled low will source current (I_{IL}) because of the internal pullups.

Some Port 1 pins provide additional functions. P1.0 and P1.1 can be configured to be the timer/counter 2 external count input (P1.0/T2) and the timer/counter 2 trigger input (P1.1/T2EX), respectively.

PLCC



Block Diagram





XTAL1

Input to the inverting oscillator amplifier and input to the internal clock operating circuit.

XTAL2

Output from the inverting oscillator amplifier.

Special Function Registers

A map of the on-chip memory area called the Special Function Register (SFR) space is shown in Table 1.

Note that not all of the addresses are occupied, and unoccupied addresses may not be implemented on the chip. Read accesses to these addresses will in general return random data, and write accesses will have an indeterminate effect.

0F8H									0FFH
0F0H	B 00000000								0F7H
0E8H									0EFH
0E0H	ACC 00000000								0E7H
0D8H									0DFH
0D0H	PSW 00000000					SPCR 000001XX			0D7H
0C8H	T2CON 00000000	T2MOD XXXXXX00	RCAP2L 00000000	RCAP2H 00000000	TL2 00000000	TH2 00000000			0CFH
0C0H									0C7H
0B8H	IP XX000000								0BFH
0B0H	P3 11111111								0B7H
0A8H	IE 0X000000		SPSR 00XXXXXX						0AFH
0A0H	P2 11111111								0A7H
98H	SCON 00000000	SBUF XXXXXXXX							9FH
90H	P1 11111111						WCON 00000010		97H
88H	TCON 00000000	TMOD 00000000	TL0 00000000	TL1 00000000	TH0 00000000	TH1 00000000			8FH
80H	P0 11111111	SP 00000111	DP0L 00000000	DP0H 00000000	DP1L 00000000	DP1H 00000000	SPDR XXXXXXXX	PCON 0XXX0000	87H

Table 1. AT89LS53 SFR Map and Reset Values





User software should not write 1s to these unlisted locations, since they may be used in future products to invoke new features. In that case, the reset or inactive values of the new bits will always be 0.

Timer 2 Registers Control and status bits are contained in registers T2CON (shown in Table 2) and T2MOD (shown in Table 9) for Timer 2. The register pair (RCAP2H, RCAP2L) are the Capture/Reload registers for Timer 2 in 16 bit capture mode or 16-bit auto-reload mode.

Watchdog Control Register The WCON register contains control bits for the Watchdog Timer (shown in Table 3). The DPS bit selects one of two DPTR registers available.

SPI Registers Control and status bits for the Serial Peripheral Interface are contained in registers SPCR (shown in Table 4) and SPSR (shown in Table 5). The SPI data bits are contained in the SPDR register. Writing the SPI data register during serial data transfer sets the Write Collision bit, WCOL, in the SPSR register. The SPDR is double buffered for writing and the values in SPDR are not changed by Reset.

Interrupt Registers The global interrupt enable bit and the individual interrupt enable bits are in the IE register. In addition, the individual interrupt enable bit for the SPI is in the SPCR register. Two priorities can be set for each of the six interrupt sources in the IP register.

Table 2. T2CON—Timer/Counter 2 Control Register

T2CON Address = 0C8H Reset Value = 0000 0000B								
Bit Addressable								
	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2
Bit	7	6	5	4	3	2	1	0
Symt	ol Eurotia	2						

Symbol	Function
TF2	Timer 2 overflow flag set by a Timer 2 overflow and must be cleared by software. TF2 will not be set when either RCLK = 1 or TCLK = 1.
EXF2	Timer 2 external flag set when either a capture or reload is caused by a negative transition on T2EX and EXEN2 = 1. When Timer 2 interrupt is enabled, EXF2 = 1 will cause the CPU to vector to the Timer 2 interrupt routine. EXF2 must be cleared by software. EXF2 does not cause an interrupt in up/down counter mode (DCEN = 1).
RCLK	Receive clock enable. When set, causes the serial port to use Timer 2 overflow pulses for its receive clock in serial port Modes 1 and 3. RCLK = 0 causes Timer 1 overflows to be used for the receive clock.
TCLK	Transmit clock enable. When set, causes the serial port to use Timer 2 overflow pulses for its transmit clock in serial port Modes 1 and 3. TCLK = 0 causes Timer 1 overflows to be used for the transmit clock.
EXEN2	Timer 2 external enable. When set, allows a capture or reload to occur as a result of a negative transition on T2EX if Timer 2 is not being used to clock the serial port. EXEN2 = 0 causes Timer 2 to ignore events at T2EX.
TR2	Start/Stop control for Timer 2. TR2 = 1 starts the timer.
C/T2	Timer or counter select for Timer 2. $C/T2 = 0$ for timer function. $C/T2 = 1$ for external event counter (falling edge triggered).
CP/RL2	Capture/Reload select. $CP/\overline{RL2} = 1$ causes captures to occur on negative transitions at T2EX if EXEN2 = 1. CP/RL2 = 0 causes automatic reloads to occur when Timer 2 overflows or negative transitions occur at T2EX when EXEN2 = 1. When either RCLK or TCLK = 1, this bit is ignored and the timer is forced to auto-reload on Timer 2 overflow.

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Dual Data Pointer Registers To facilitate accessing external data memory, two banks of 16 bit Data Pointer Registers are provided: DP0 at SFR address locations 82H-83H and DP1 at 84H-85H. Bit DPS = 0 in SFR WCON selects DP0 and DPS = 1 selects DP1. The user should always initalize the DPS bit to the appropriate value before accessing the respective Data Pointer register.

Power Off Flag The Power Off Flag (POF) is located at bit_4 (PCON.4) in the PCON SFR. POF is set to "1" during power up. It can be set and reset under software control and is not affected by RESET.

Table 3. WCON—Watchdog Control Register

Reset Value = 0000 0010B WCON Address = 96H PS2 PS1 PS0 DPS WDTRST WDTEN reserved reserved 6 5 4 3 2 0 Bit 7 1

Symbol	Function
PS2 PS1 PS0	Prescaler Bits for the Watchdog Timer. When all three bits are set to "0", the watchdog timer has a nominal period of 16 ms. When all three bits are set to "1", the nominal period is 2048 ms.
DPS	Data Pointer Register Select. DPS = 0 selects the first bank of Data Pointer Register, DP0, and DPS = 1 selects the second bank, DP1
WDTRST	Watchdog Timer Reset. Each time this bit is set to "1" by user software, a pulse is generated to reset the watchdog timer. The WDTRST bit is then automatically reset to "0" in the next instruction cycle. The WDTRST bit is Write-Only.
WDTEN	Watchdog Timer Enable Bit. WDTEN = 1 enables the watchdog timer and WDTEN = 0 disables the watchdog timer.



Table 6. SPDR—SPI Data Register

SPDF	R Address =	86H				Re	set Value = unc	hanged
	SDD 2	SBDE	SPD5	2002	2002		8000	7

	SPD7	SPD6	SPD5	SPD4	SPD3	SPD2	SPD1	SPD0
Bit	7	6	5	4	3	2	1	0

Data Memory - RAM

The AT89LS53 implements 256 bytes of RAM. The upper 128 bytes of RAM occupy a parallel space to the Special Function Registers. That means the upper 128 bytes have the same addresses as the SFR space but are physically separate from SFR space.

When an instruction accesses an internal location above address 7FH, the address mode used in the instruction specifies whether the CPU accesses the upper 128 bytes of RAM or the SFR space. Instructions that use direct addressing access SFR space.

For example, the following direct addressing instruction accesses the SFR at location 0A0H (which is P2).

MOV 0A0H, #data

Instructions that use indirect addressing access the upper 128 bytes of RAM. For example, the following indirect addressing instruction, where R0 contains 0A0H, accesses the data byte at address 0A0H, rather than P2 (whose address is 0A0H).

MOV @R0, #data

Note that stack operations are examples of indirect addressing, so the upper 128 bytes of data RAM are available as stack space.

Programmable Watchdog Timer

The programmable Watchdog Timer (WDT) operates from an independent oscillator. The prescaler bits, PS0, PS1 and PS2 in SFR WCON are used to set the period of the Watchdog Timer from 16 ms to 2048 ms. The available timer periods are shown in the following table and the actual timer periods (at $V_{CC} = 5V$) are within ±30% of the nominal.

The WDT is disabled by Power-on Reset and during Power Down. It is enabled by setting the WDTEN bit in SFR WCON (address = 96H). The WDT is reset by setting the WDTRST bit in WCON. When the WDT times out without being reset or disabled, an internal RST pulse is generated to reset the CPU.

 Table 7. Watchdog Timer Period Selection

WDT	Prescaler I	Bits	
PS2	PS1	PS0	Period (nominal)
0	0	0	16 ms
0	0	1	32 ms
0	1	0	64 ms
0	1	1	128 ms
1	0	0	256 ms
1	0	1	512 ms
1	1	0	1024 ms
1	1	1	2048 ms





Timer 0 and 1

Timer 0 and Timer 1 in the AT89LS53 operate the same way as Timer 0 and Timer 1 in the AT89C51, AT89C52 and AT89C55. For further information, see the October 1995 Microcontroller Data Book, page 2-45, section titled, "Timer/Counters."

Timer 2

Timer 2 is a 16 bit Timer/Counter that can operate as either a timer or an event counter. The type of operation is selected by bit $C/\overline{12}$ in the SFR T2CON (shown in Table 2). Timer 2 has three operating modes: capture, auto-reload (up or down counting), and baud rate generator. The modes are selected by bits in T2CON, as shown in Table 8.

Timer 2 consists of two 8-bit registers, TH2 and TL2. In the Timer function, the TL2 register is incremented every machine cycle. Since a machine cycle consists of 12 oscillator periods, the count rate is 1/12 of the oscillator frequency.

In the Counter function, the register is incremented in response to a 1-to-0 transition at its corresponding external input pin, T2. In this function, the external input is sampled during S5P2 of every machine cycle. When the samples show a high in one cycle and a low in the next cycle, the count is incremented. The new count value appears in the register during S3P1 of the cycle following the one in which the transition was detected. Since two machine cycles (24 oscillator periods) are required to recognize a 1-to-0 transition, the maximum count rate is 1/24 of the oscillator frequency. To ensure that a given level is sampled at least once before it changes, the level should be held for at least one full machine cycle.

Table 8. Timer 2 Operating Modes

RCLK + TCLK	CP/RL2	TR2	MODE
0	0	1	16-bit Auto-Reload
0	1	1	16-bit Capture
1	х	1	Baud Rate Generator
Х	Х	0	(Off)

Capture Mode

In the capture mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 is a 16 bit timer or counter which upon overflow sets bit TF2 in T2CON. This bit can then be used to generate an interrupt. If EXEN2 = 1, Timer 2 performs the same operation, but a 1-to-0 transition at external input T2EX also causes the current value in TH2 and TL2 to be captured into RCAP2H and RCAP2L, respectively. In addition, the transition at T2EX causes bit EXF2 in T2CON to be set. The EXF2 bit, like TF2, can generate an interrupt. The capture mode is illustrated in Figure 1.

Auto-Reload (Up or Down Counter)

Timer 2 can be programmed to count up or down when configured in its 16 bit auto-reload mode. This feature is invoked by the DCEN (Down Counter Enable) bit located in the SFR T2MOD (see Table 9). Upon reset, the DCEN bit is set to 0 so that timer 2 will default to count up. When DCEN is set, Timer 2 can count up or down, depending on the value of the T2EX pin.

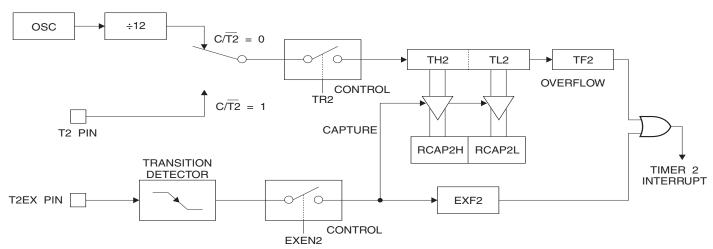


Figure 1. Timer 2 in Capture Mode

Figure 2 shows Timer 2 automatically counting up when DCEN = 0. In this mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 counts up to 0FFFFH and then sets the TF2 bit upon overflow. The overflow also causes the timer registers to be reloaded with the 16 bit value in RCAP2H and RCAP2L. The values in RCAP2H and RCAP2L are preset by software. If EXEN2 = 1, a 16 bit reload can be triggered either by an overflow or

by a 1-to-0 transition at external input T2EX. This transition also sets the EXF2 bit. Both the TF2 and EXF2 bits can generate an interrupt if enabled.

Setting the DCEN bit enables Timer 2 to count up or down, as shown in Figure 3. In this mode, the T2EX pin controls

the direction of the count. A logic 1 at T2EX makes Timer 2 count up. The timer will overflow at 0FFFFH and set the TF2 bit. This overflow also causes the 16 bit value in RCAP2H and RCAP2L to be reloaded into the timer registers, TH2 and TL2, respectively.

A logic 0 at T2EX makes Timer 2 count down. The timer underflows when TH2 and TL2 equal the values stored in RCAP2H and RCAP2L. The underflow sets the TF2 bit and causes 0FFFFH to be reloaded into the timer registers.

The EXF2 bit toggles whenever Timer 2 overflows or underflows and can be used as a 17th bit of resolution. In this operating mode, EXF2 does not flag an interrupt.

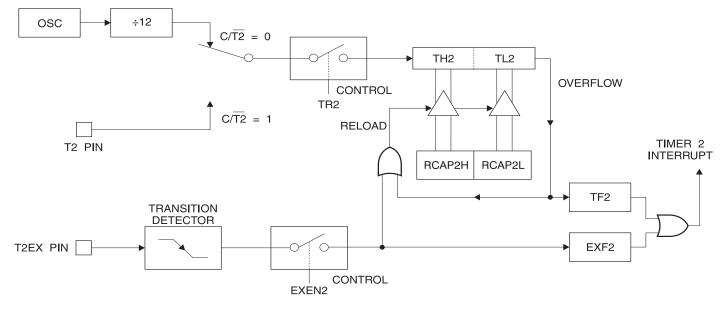


Figure 2. Timer 2 in Auto Reload Mode (DCEN = 0)

Table 9.	T2MOD—Timer 2 Mode Control Register
----------	-------------------------------------

T2MOD Address = 0C9H Reset Value = XXXX XX								00B	
Not Bit Addressable									
		—	—	—	—	—	T2OE	DCEN	
Bit	7	6	5	4	3	2	1	0	

Symbol	Function	
—	implemented, reserved for future use.	
T2OE	imer 2 Output Enable bit.	
DCEN	When set, this bit allows Timer 2 to be configured as an up/down counter.	





Figure 3. Timer 2 Auto Reload Mode (DCEN = 1)

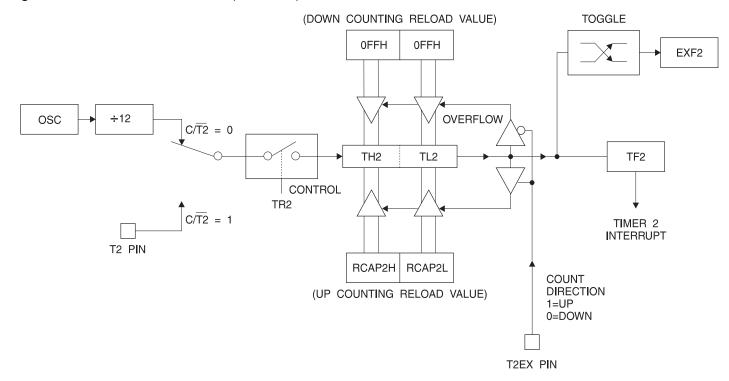
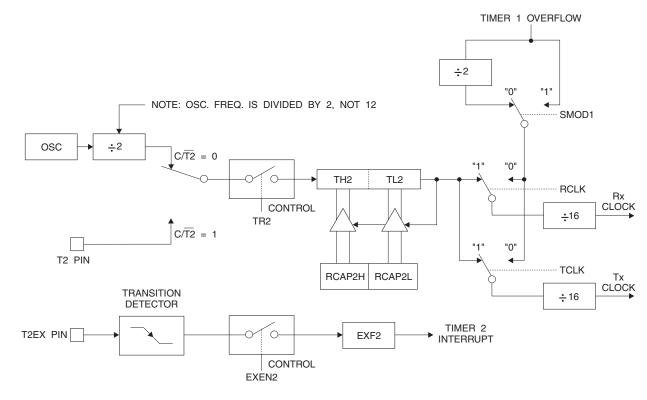


Figure 4. Timer 2 in Baud Rate Generator Mode



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Programmable Clock Out

A 50% duty cycle clock can be programmed to come out on P1.0, as shown in Figure 5. This pin, besides being a regular I/0 pin, has two alternate functions. It can be programmed to input the external clock for Timer/Counter 2 or to output a 50% duty cycle clock ranging from 61 Hz to 3 MHz at a 12 MHz operating frequency.

To configure the Timer/Counter 2 as a clock generator, bit $C/\overline{T2}$ (T2CON.1) must be cleared and bit T2OE (T2MOD.1) must be set. Bit TR2 (T2CON.2) starts and stops the timer.

The clock-out frequency depends on the oscillator frequency and the reload value of Timer 2 capture registers (RCAP2H, RCAP2L), as shown in the following equation.

Clock-Out Frequency= $\frac{\text{Oscillator Frequency}}{4 \times [65536 - (\text{RCAP2H}, \text{RCAP2L})]}$

In the clock-out mode, Timer 2 rollovers will not generate an interrupt. This behavior is similar to when Timer 2 is used as a baud-rate generator. It is possible to use Timer 2 as a baud-rate generator and a clock generator simultaneously. Note, however, that the baud-rate and clock-out frequencies cannot be determined independently from one another since they both use RCAP2H and RCAP2L.

UART

The UART in the AT89LS53 operates the same way as the UART in the AT89C51, AT89C52 and AT89C55. For further information, see the October 1995 Atmel Microcontroller Data Book, page 2-49, section titled, "Serial Interface."

Serial Peripheral Interface

The serial peripheral interface (SPI) allows high-speed synchronous data transfer between the AT89LS53 and peripheral devices or between several AT89LS53 devices. The AT89LS53 SPI features include the following:

- Full-Duplex, 3-Wire Synchronous Data Transfer
- Master or Slave Operation
- 1.5-MHz Bit Frequency (max.)
- LSB First or MSB First Data Transfer
- Four Programmable Bit Rates
- End of Transmission Interrupt Flag
- Write Collision Flag Protection
- Wakeup from Idle Mode (Slave Mode Only)

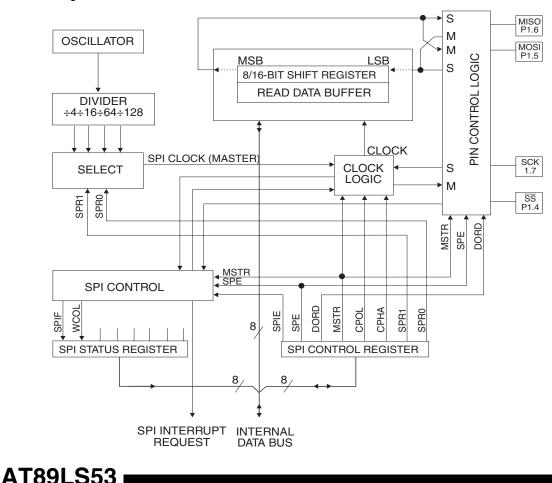
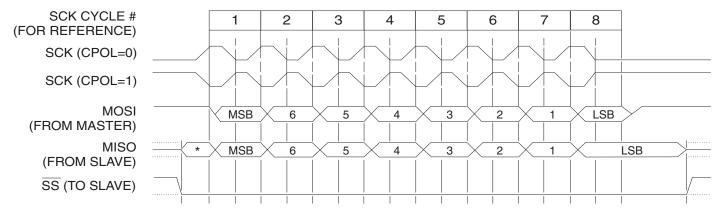


Figure 6. SPI Block Diagram

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Figure 9. SPI Transfer Format with CPHA = 1



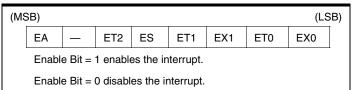
*Not defined but normally LSB of previously transmitted character

Interrupts

The AT89LS53 has a total of six interrupt vectors: two external interrupts (INTO and INT1), three timer interrupts (Timers 0, 1, and 2), and the serial port interrupt. These interrupts are all shown in Figure 10.

Each of these interrupt sources can be individually enabled or disabled by setting or clearing a bit in Special Function Register IE. IE also contains a global disable bit, EA, which disables all interrupts at once.

Note that Table 10 shows that bit position IE.6 is unimplemented. In the AT89C51 and AT89LV51, bit position IE.5 is also unimplemented. User software should not write 1s to



Symbol	Position	Function			
EA	IE.7	Disables all interrupts. If EA = 0, no interrupt is acknowledged. If EA = 1, each interrupt source is individually enabled or disabled by setting or clearing its enable bit.			
—	IE.6	Reserved.			
ET2	IE.5	Timer 2 interrupt enable bit.			
ES	IE.4	SPI and UART interrupt enable bit.			
ET1	IE.3	Timer 1 interrupt enable bit.			
EX1	IE.2	External interrupt 1 enable bit.			
ET0	IE.1	Timer 0 interrupt enable bit.			
EX0	IE.0	External interrupt 0 enable bit.			
User software should never write 1s to unimplemented bits, because they may be used in future AT89 products.					

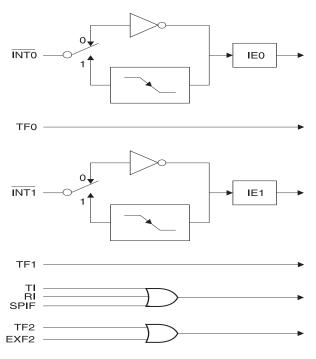
Table 10. Interrupt Enable (IE) Register

these bit positions, since they may be used in future AT89 products.

Timer 2 interrupt is generated by the logical OR of bits TF2 and EXF2 in register T2CON. Neither of these flags is cleared by hardware when the service routine is vectored to. In fact, the service routine may have to determine whether it was TF2 or EXF2 that generated the interrupt, and that bit will have to be cleared in software.

The Timer 0 and Timer 1 flags, TF0 and TF1, are set at S5P2 of the cycle in which the timers overflow. The values are then polled by the circuitry in the next cycle. However, the Timer 2 flag, TF2, is set at S2P2 and is polled in the same cycle in which the timer overflows.

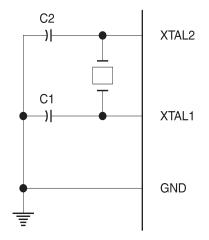
Figure 10. Interrupt Sources



AT89LS53

AT89LS53

Figure 11. Oscillator Connections



Note: C1, C2 = 30 pF \pm 10 pF for Crystals = 40 pF \pm 10 pF for Ceramic Resonators

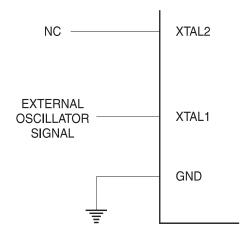
Oscillator Characteristics

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier that can be configured for use as an on-chip oscillator, as shown in Figure 11. Either a quartz crystal or ceramic resonator may be used. To drive the device from an external clock source, XTAL2 should be left unconnected while XTAL1 is driven, as shown in Figure 12. There are no requirements on the duty cycle of the external clock signal, since the input to the internal clocking circuitry is through a divide-by-two flip-flop, but minimum and maximum voltage high and low time specifications must be observed.

Idle Mode

In idle mode, the CPU puts itself to sleep while all the onchip peripherals remain active. The mode is invoked by software. The content of the on-chip RAM and all the special functions registers remain unchanged during this mode. The idle mode can be terminated by any enabled interrupt or by a hardware reset.

Note that when idle mode is terminated by a hardware reset, the device normally resumes program execution from where it left off, up to two machine cycles before the Figure 12. External Clock Drive Configuration



internal reset algorithm takes control. On-chip hardware inhibits access to internal RAM in this event, but access to the port pins is not inhibited. To eliminate the possibility of an unexpected write to a port pin when idle mode is terminated by a reset, the instruction following the one that invokes idle mode should not write to a port pin or to external memory.

Power Down Mode

In the power down mode, the oscillator is stopped and the instruction that invokes power down is the last instruction executed. The on-chip RAM and Special Function Registers retain their values until the power down mode is terminated. Exit from power down can be initiated either by a hardware reset or by an enabled external interrupt. Reset redefines the SFRs but does not change the on-chip RAM. The reset should not be activated before V_{CC} is restored to its normal operating level and must be held active long enough to allow the oscillator to restart and stabilize.

To exit power down via an interrupt, the external interrupt must be enabled as level sensitive before entering power down. The interrupt service routine starts at 16 ms (nominal) after the enabled interrupt pin is activated.

Status of External Pins During Idle and Power Down Modes

Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power Down	Internal	0	0	Data	Data	Data	Data
Power Down	External	0	0	Float	Data	Data	Data





Program Memory Lock Bits

The AT89LS53 has three lock bits that can be left unprogrammed (U) or can be programmed (P) to obtain the additional features listed in the following table.

When lock bit 1 is programmed, the logic level at the \overline{EA} pin is sampled and latched during reset. If the device is powered up without a reset, the latch initializes to a random

value and holds that value until reset is activated. The latched value of \overline{EA} must agree with the current logic level at that pin in order for the device to function properly.

Once programmed, the lock bits can only be unprogrammed with the Chip Erase operations in either the parallel or serial modes.

Lock Bit Protection Modes ^{(1) (2)}

Program Lock Bits		Bits			
	LB1 LB2 LB3 Protection Type				
1	1 U U U No internal memory lock feature.				
2	P U U MOVC instructions executed from external program memory are disabled from fetching code bytes from internal memory. EA is sampled and latched on reset and further programming of the Flash memory (parallel or serial mode) is disabled.				
3	Р	P U Same as Mode 2, but parallel or serial verify are also disabled.			
4	Р	Р	Р	Same as Mode 3, but external execution is also disabled.	

Notes: 1. U = Unprogrammed

2. P = Programmed

Programming the Flash

Atmel's AT89LS53 Flash Microcontroller offers 12K bytes of in-system reprogrammable Flash Code memory.

The AT89LS53 is normally shipped with the on-chip Flash Code memory array in the erased state (i.e. contents = FFH) and ready to be programmed. This device supports a High-Voltage (12V) Parallel programming mode and a Low-Voltage (2.7 to 6.0V) Serial programming mode. The serial programming mode provides a convenient way to download the AT89LS53 inside the user's system. The parallel programming mode is compatible with conventional third party Flash or EPROM programmers.

The Code memory array occupies one contiguous address space from 0000H to 2FFFH.

The Code array on the AT89LS53 is programmed byte-bybyte in either programming mode. An auto-erase cycle is provided with the self-timed programming operation in the serial programming mode. There is no need to perform the Chip Erase operation to reprogram any memory location in the serial programming mode unless any of the lock bits have been programmed.

In the parallel programming mode, there is no auto-erase cycle. To reprogram any non-blank byte, the user needs to use the Chip Erase operation first to erase the entire Code memory array.

Parallel Programming Algorithm

To program and verify the AT89LS53 in the parallel programming mode, the following sequence is recommended:

1. Power-up sequence:

Apply power between V_{CC} and GND pins. Set RST pin to "H".

Apply a 3 MHz to 12 MHz clock

Apply a 3 MHz to 12 MHz clock to XTAL1 pin and wait for at least 10 milliseconds.

- Set PSEN pin to "L"
 ALE pin to "H"
 EA pin to "H" and all other pins to "H".
- 3. Apply the appropriate combination of "H" or "L" logic levels to pins P2.6, P2.7, P3.6, P3.7 to select one of the programming operations shown in the Flash Programming Modes table.
- Apply the desired byte address to pins P1.0 to P1.7 and P2.0 to P2.5.
 Apply data to pins P0.0 to P0.7 for Write Code operation.
- 5. Raise \overline{EA}/V_{PP} to 12V to enable Flash programming, erase or verification.
- 6. Pulse ALE/PROG once to program a byte in the Code memory array, or the lock bits. The byte-write cycle is self-timed and typically takes 1.5 ms.

- 7. To verify the byte just programmed, bring pin P2.7 to "L" and read the programmed data at pins P0.0 to P0.7.
- 8. Repeat steps 3 through 7 changing the address and data for the entire 12K-byte array or until the end of the object file is reached.
- 9. Power-off sequence:

Set XTAL1 to <u>"L"</u>.

Set RST and \overline{EA} pins to "L".

Turn V_{CC} power off.

DATA Polling

The AT89LS53 features DATA Polling to indicate the end of a write cycle. During a write cycle in the parallel or serial programming mode, an attempted read of the last byte written will result in the complement of the written datum on P0.7 (parallel mode), and on the MSB of the serial output byte on MISO (serial mode). Once the write cycle has been completed, true data are valid on all outputs, and the next cycle may begin. DATA Polling may begin any time after a write cycle has been initiated.

Ready/Busy

The progress of byte programming in the parallel programming mode can also be monitored by the RDY/BSY output signal. Pin P3.4 is pulled Low after ALE goes High during programming to indicate BUSY. P3.4 is pulled High again when programming is done to indicate READY.

Program Verify

If lock bits LB1 and LB2 have not been programmed, the programmed Code can be read back via the address and data lines for verification. The state of the lock bits can also be verified directly in the parallel programming mode. In the serial programming mode, the state of the lock bits can only be verified indirectly by observing that the lock bit features are enabled.

Chip Erase

In the parallel programming mode, chip erase is initiated by using the proper combination of control signals and by holding ALE/PROG low for 10 ms. The Code array is written with all "1"s in the Chip Erase operation.

In the serial programming mode, a chip erase operation is initiated by issuing the Chip Erase instruction. In this mode, chip erase is self-timed and takes about 16 ms.

During chip erase, a serial read from any address location will return 00H at the data outputs.

Serial Programming Fuse

A programmable fuse is available to disable Serial Programming if the user needs maximum system security. The Serial Programming Fuse can only be programmed or erased in the Parallel Programming Mode.

The AT89LS53 is shipped with the Serial Programming Mode enabled.

Reading the Signature Bytes: The signature bytes are read by the same procedure as a normal verification of locations 030H and 031H, except that P3.6 and P3.7 must be pulled to a logic low. The values returned are as follows:

(030H) = 1EH indicates manufactured by Atmel (031H) = 63H indicates 89LS53

Programming Interface

Every code byte in the Flash array can be written, and the entire array can be erased, by using the appropriate combination of control signals. The write operation cycle is selftimed and once initiated, will automatically time itself to completion.

All major programming vendors offer worldwide support for the Atmel microcontroller series. Please contact your local programming vendor for the appropriate software revision.

Serial Downloading

The Code memory array can be programmed using the serial SPI bus while RST is pulled to V_{CC} . The serial interface consists of pins SCK, MOSI (input) and MISO (output). After RST is set high, the Programming Enable instruction needs to be executed first before program/erase operations can be executed.

An auto-erase cycle is built into the self-timed programming operation (in the serial mode ONLY) and there is no need to first execute the Chip Erase instruction unless any of the lock bits have been programmed. The Chip Erase operation turns the content of every memory location in the Code array into FFH.

The Code memory array has an address space of 0000H to 2FFFH.

Either an external system clock is supplied at pin XTAL1 or a crystal needs to be connected across pins XTAL1 and XTAL2. The maximum serial clock (SCK) frequency should be less than 1/40 of the crystal frequency. With a 12 MHz oscillator clock, the maximum SCK frequency is 300 KHz.





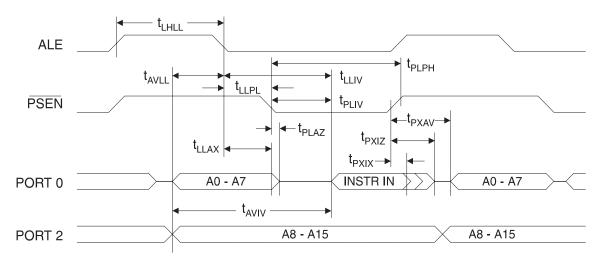
AC Characteristics

Under operating conditions, load capacitance for Port 0, ALE/ \overline{PROG} , and $\overline{PSEN} = 100 \text{ pF}$; load capacitance for all other outputs = 80 pF.

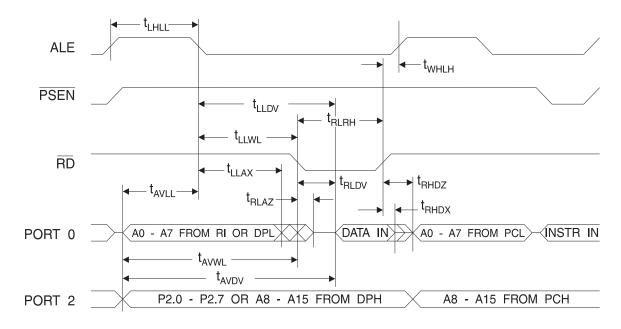
External Program and Data Memory Characteristics

		12MHz C	Oscillator	Variable	Variable Oscillator	
Symbol	Parameter	Min	Max	Min	Max	Units
1/t _{CLCL}	Oscillator Frequency			0	12	MHz
t _{LHLL}	ALE Pulse Width	127		2t _{CLCL} - 40		ns
t _{AVLL}	Address Valid to ALE Low	43		t _{CLCL} - 40		ns
t _{LLAX}	Address Hold After ALE Low	48		t _{CLCL} - 35		ns
t _{LLIV}	ALE Low to Valid Instruction In		233		4t _{CLCL} - 100	ns
t _{LLPL}	ALE Low to PSEN Low	43		t _{CLCL} - 40		ns
t _{PLPH}	PSEN Pulse Width	205		3t _{CLCL} - 45		ns
t _{PLIV}	PSEN Low to Valid Instruction In		145		3t _{CLCL} - 105	ns
t _{PXIX}	Input Instruction Hold After PSEN	0		0		ns
t _{PXIZ}	Input Instruction Float After PSEN		59		t _{CLCL} - 25	ns
t _{PXAV}	PSEN to Address Valid	75		t _{CLCL} - 8		ns
t _{AVIV}	Address to Valid Instruction In		312		5t _{CLCL} - 105	ns
t _{PLAZ}	PSEN Low to Address Float		10		10	ns
t _{RLRH}	RD Pulse Width	400		6t _{CLCL} - 100		ns
t _{WLWH}	WR Pulse Width	400		6t _{CLCL} - 100		ns
t _{RLDV}	RD Low to Valid Data In		252		5t _{CLCL} - 165	ns
t _{RHDX}	Data Hold After RD	0		0		ns
t _{RHDZ}	Data Float After RD		97		2t _{CLCL} - 70	ns
t _{LLDV}	ALE Low to Valid Data In		517		8t _{CLCL} - 150	ns
t _{AVDV}	Address to Valid Data In		585		9t _{CLCL} - 165	ns
t _{LLWL}	ALE Low to \overline{RD} or \overline{WR} Low	200	300	3t _{CLCL} - 50	3t _{CLCL} + 50	ns
t _{AVWL}	Address to RD or WR Low	203		4t _{CLCL} - 130		ns
t _{QVWX}	Data Valid to WR Transition	23		t _{CLCL} - 60		ns
t _{QVWH}	Data Valid to WR High	433		7t _{CLCL} - 150		ns
t _{WHQX}	Data Hold After WR	33		t _{CLCL} - 50		ns
t _{RLAZ}	RD Low to Address Float		0		0	ns
t _{WHLH}	RD or WR High to ALE High	43	123	t _{CLCL} - 40	t _{CLCL} + 40	ns

External Program Memory Read Cycle

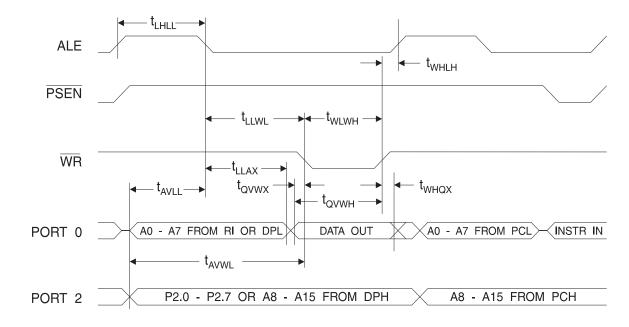


External Data Memory Read Cycle



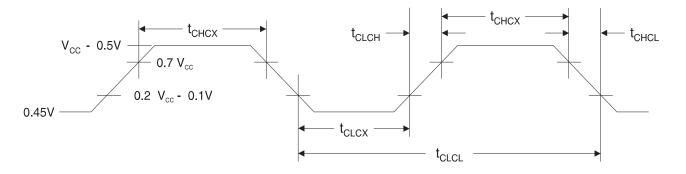






External Data Memory Write Cycle

External Clock Drive Waveforms

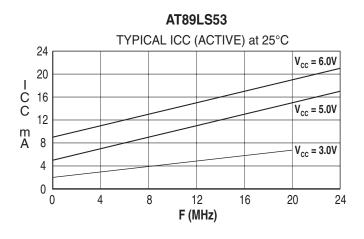


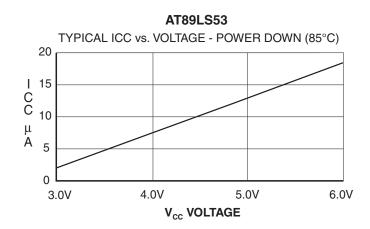
External Clock Drive

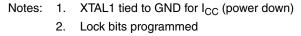
		١	V _{CC} = 2.7V to 6.0V			
Symbol	Parameter	Min	Max	Units		
1/t _{CLCL}	Oscillator Frequency	0	12	MHz		
t _{CLCL}	Clock Period	83.3		ns		
t _{CHCX}	High Time	30		ns		
t _{CLCX}	Low Time	30		ns		
t _{CLCH}	Rise Time		20	ns		
t _{CHCL}	Fall Time		20	ns		

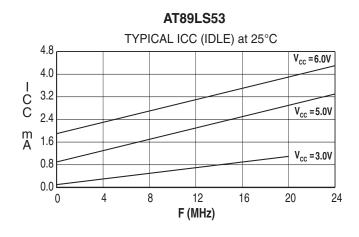
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Ordering Information

Speed (MHz)	Power Supply	Ordering Code	Package	Operation Range
12	2.7V to 6.0V	AT89LS53-12AC AT89LS53-12JC AT89LS53-12PC	44A 44J 40P6	Commercial (0°C to 70°C)
	2.7V to 6.0V	AT89LS53-12AI AT89LS53-12JI AT89LS53-12PI	44A 44J 40P6	Industrial (-40°C to 85°C)

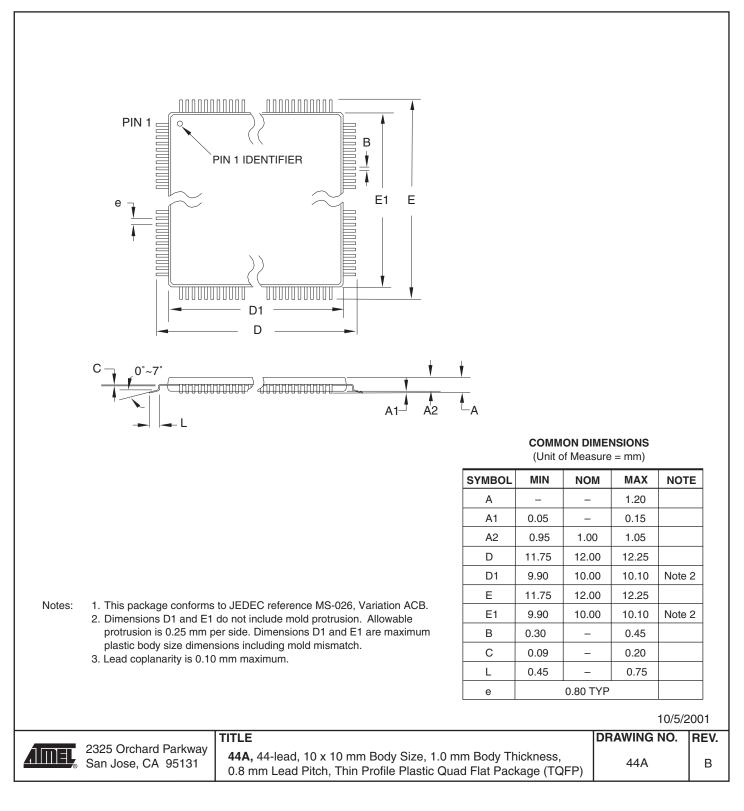
Package Type				
44 A	44 Lead, Thin Plastic Gull Wing Quad Flatpack (TQFP)			
44J	44 Lead, Plastic J-Leaded Chip Carrier (PLCC)			
40P6	40 Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)			





Packaging Information

44A – TQFP



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